# 1-1470108-2 - ACTIVE

TE Internal #: 1-1470108-2 PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural

### View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.0 mm Headers



Connector System: Wire-to-Board

Number of Positions: 12

Number of Rows: 2

Centerline (Pitch): 2 mm [.079 in ]

PCB Mount Orientation: Right Angle

All AMP HPI 2.0 mm Headers (206)

# Features

### Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	12
Number of Rows	2
PCB Mount Orientation	Right Angle
Electrical Characteristics	
Insulation Resistance	5000 ΜΩ
Operating Voltage	100 VDC

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## **Body Features**

Primary Product Color	Natural
Contact Features	
Contact Mating Area Length	3.5 mm[.138 in]
Mating Square Post Dimension	.5 mm[.02 in]
	100 µin
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3 mm[.118 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

# Mechanical Attachment

Mating Alignment Type	Keyed
Mating Retention	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Nylon 66
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2 mm[.079 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	

**C** For support call+1 800 522 6752

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Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Loose Piece
Other	
Position Locations Omitted	0
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235)

### Halogen Content

Solder Process Capability

SVHC > Threshold:

### Pb (.5% in Component Part)

#### Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts

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# Customers Also Bought



03P.CIS FEM ASS P1



### Documents

Product Drawings 2.0MM PITCH HEADER, DIP 12P

English

### **CAD** Files

Customer View Model

### ENG\_CVM\_CVM\_1-1470108-2\_F.2d\_dxf.zip

English

3D PDF

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3D

Customer View Model ENG\_CVM\_CVM\_1-1470108-2\_F.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-1470108-2\_F.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION3AND4

English

HPI Connectors QRG

English

**Product Specifications** 

AMP 2.0mm PITCH EMIX Economic Metric Interconnect Series, Wire-To-Board System.

English

**Application Specification** 

English